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FAST SWITCHING THYRISTOR

ATF401

Repetitive voltage up to **800 V**
Mean on-state current **890 A**
Surge current **12 kA**
Turn-off time **20 μs**

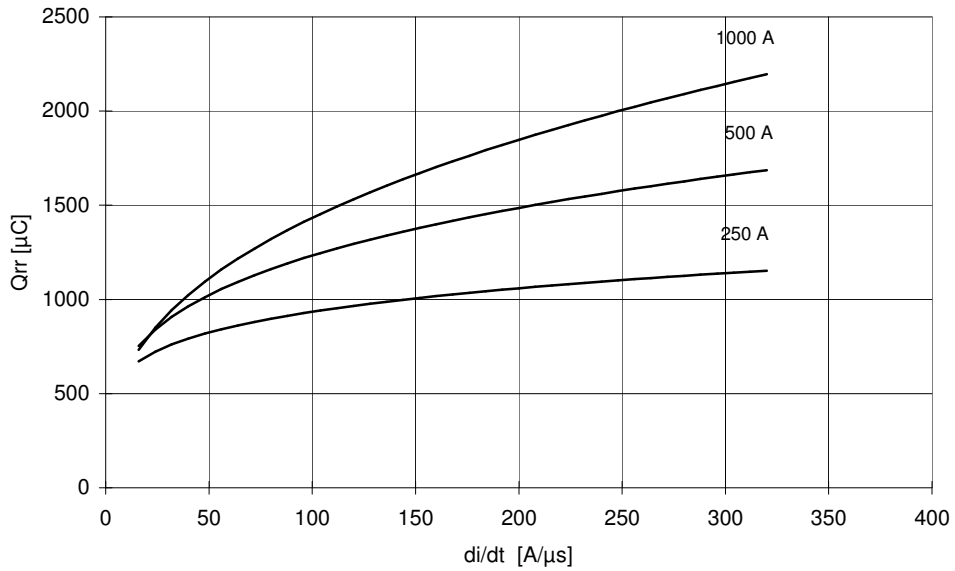
FINAL SPECIFICATION

mag 06 - ISSUE : 05

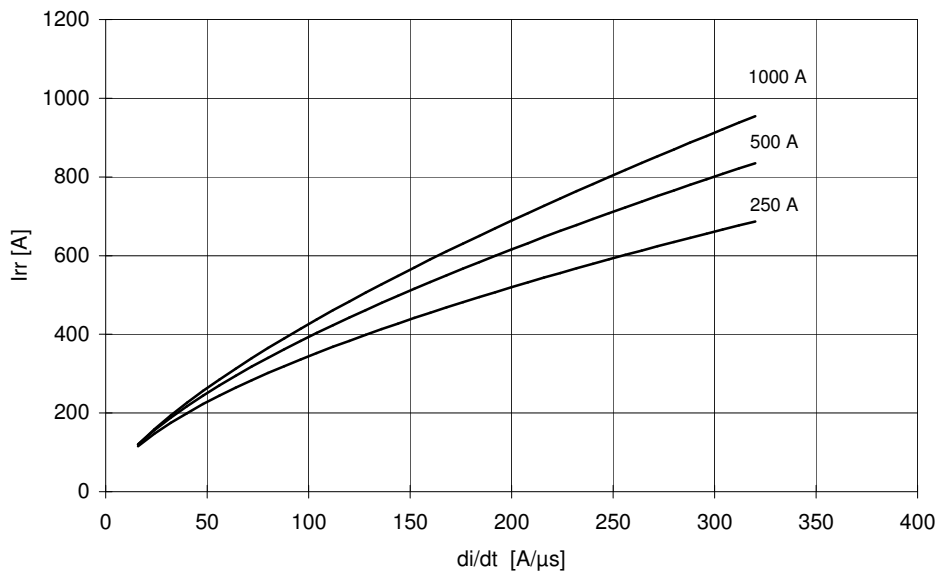
Symbol	Characteristic	Conditions	T _j [°C]	Value	Unit																				
BLOCKING																									
V _{RRM}	Repetitive peak reverse voltage		125	800	V																				
V _{RSM}	Non-repetitive peak reverse voltage		125	900	V																				
V _{DRM}	Repetitive peak off-state voltage		125	800	V																				
I _{RRM}	Repetitive peak reverse current	V=VRRM	125	75	mA																				
I _{DRM}	Repetitive peak off-state current	V=VDRM	125	75	mA																				
CONDUCTING																									
I _{T(AV)}	Mean on-state current	180° sin, 50 Hz, Th=55°C, double side cooled		890	A																				
I _{T(AV)}	Mean on-state current	180° sin, 1 kHz, Th=55°C, double side cooled		770	A																				
I _{TSM}	Surge on-state current, non repetitive	sine wave, 10 ms	125	12	kA																				
I ² t	I ² t	without reverse voltage		720 x1E3	A ² s																				
V _T	On-state voltage	On-state current = 2000 A	125	0,7	V																				
V _{T(TO)}	Threshold voltage		125	1,35	V																				
r _T	On-state slope resistance		125	0,350	mohm																				
SWITCHING																									
di/dt	Critical rate of rise of on-state current, min	From 75% VDRM up to 1200 A, gate 10V 5 ohm	125	400	A/μs																				
dv/dt	Critical rate of rise of off-state voltage, min	Linear ramp up to 75% of VDRM	125	600	V/μs																				
t _d	Gate controlled delay time, typical	VD=200V, gate source 20V, 10 ohm, tr=.5 μs	25	0,3	μs																				
t _q	Circuit commutated turn-off time	di/dt = 60 A/μs, I = 1000 A dV/dt = 200 V/μs, up to 80% VDRM	125	20	μs																				
Q _{rr}	Reverse recovery charge	di/dt = 60 A/μs, I = 1000 A	125	60	μC																				
I _{rr}	Peak reverse recovery current	VR = 50 V		80	A																				
I _H	Holding current, typical	VD=5V, gate open circuit	25		mA																				
I _L	Latching current, typical	VD=12V, tp=30μs	25		mA																				
GATE																									
V _{GT}	Gate trigger voltage	VD=5V	25	3,5	V																				
I _{GT}	Gate trigger current	VD=5V	25	350	mA																				
V _{GD}	Non-trigger gate voltage, min.	VD=VDRM	125	0,25	V																				
V _{FGM}	Peak gate voltage (forward)		25	30	V																				
I _{FGM}	Peak gate current		25	10	A																				
V _{RGM}	Peak gate voltage (reverse)		25	5	V																				
P _{GM}	Peak gate power dissipation	Pulse width 100 μs	25	150	W																				
P _{G(AV)}	Average gate power dissipation		25	2	W																				
MOUNTING																									
R _{th(j-h)}	Thermal impedance, DC	Junction to heatsink, double side cooled		37	°C/kW																				
T _j	Operating junction temperature			-30 / 125	°C																				
F	Mounting force			11.0 / 13.0	kN																				
	Mass			320	g																				
ORDERING INFORMATION : ATF401 S 08 A _____ tq code																									
standard specification _____ VDRM&VRRM/100																									
<table border="1"> <thead> <tr> <th colspan="5">tq code</th> </tr> </thead> <tbody> <tr> <td>D 10 μs</td> <td>C 12 μs</td> <td>B 15 μs</td> <td>A 20 μs</td> <td>L 25 μs</td> </tr> <tr> <td>M 30 μs</td> <td>N 35 μs</td> <td>P 40 μs</td> <td>R 45 μs</td> <td>S 50 μs</td> </tr> <tr> <td>T 60 μs</td> <td>U 70 μs</td> <td>W 80 μs</td> <td>X 100μs</td> <td>Y 150μs</td> </tr> </tbody> </table>						tq code					D 10 μs	C 12 μs	B 15 μs	A 20 μs	L 25 μs	M 30 μs	N 35 μs	P 40 μs	R 45 μs	S 50 μs	T 60 μs	U 70 μs	W 80 μs	X 100μs	Y 150μs
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SWITCHING CHARACTERISTICS

REVERSE RECOVERY CHARGE
 $T_j = 125\text{ }^\circ\text{C}$



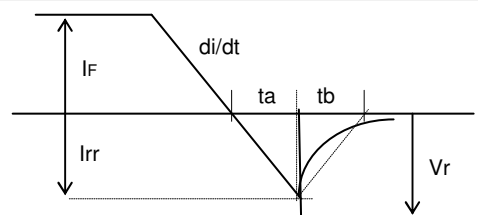
REVERSE RECOVERY CURRENT
 $T_j = 125\text{ }^\circ\text{C}$



$$t_a = I_{rr} / (di/dt) \quad t_b = t_{rr} - t_a$$

$$\text{Softness (s factor)} \quad s = t_b / t_a$$

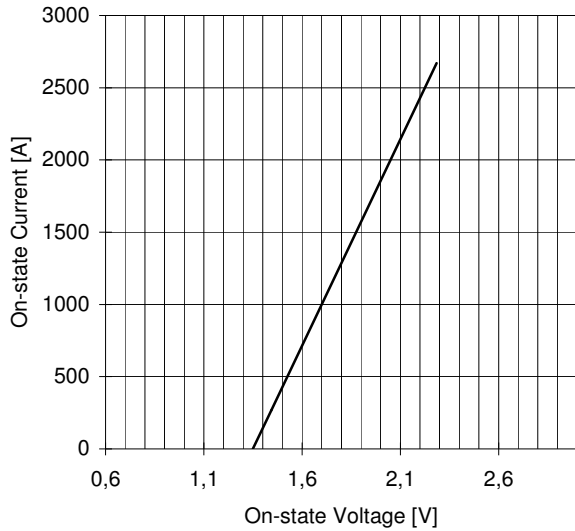
$$\text{Energy dissipation during recovery } E_r = V_r \cdot (Q_{rr} - I_{rr} \cdot t_a / 2)$$



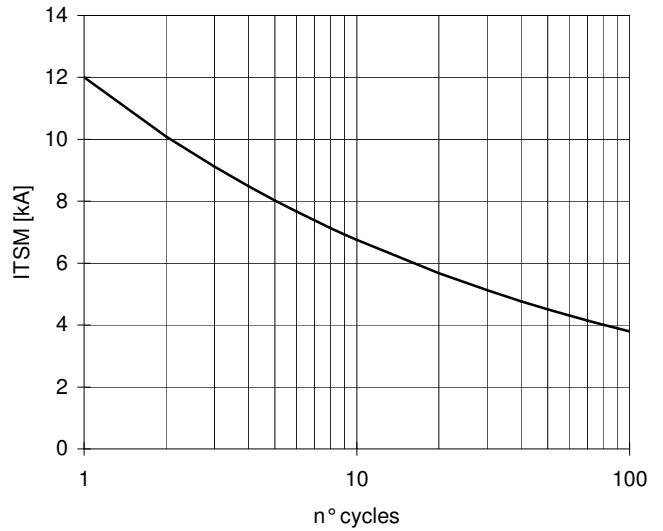
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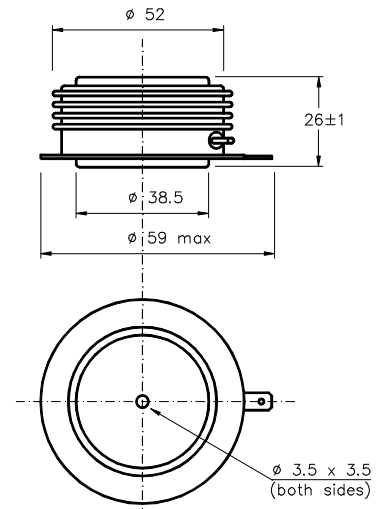
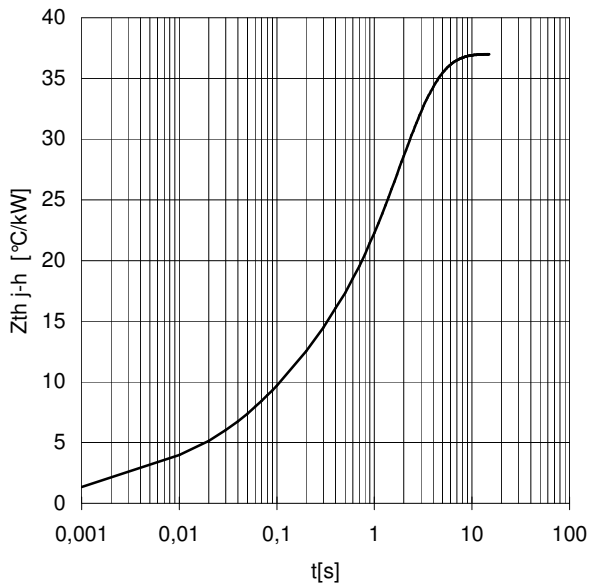
ON-STATE CHARACTERISTIC
 $T_j = 125\text{ }^\circ\text{C}$



SURGE CHARACTERISTIC
 $T_j = 125\text{ }^\circ\text{C}$



TRANSIENT THERMAL IMPEDANCE
DOUBLE SIDE COOLED



Dimensions
in mm



Cathode terminal type DIN 46244 - A 4.8 - 0.8

Gate terminal type AMP 60598 - 1

All the characteristics given in this data sheet are guaranteed only with uniform clamping force, cleaned and lubricated heatsink, surfaces with flatness < .03 mm and roughness < 2 μm .

In the interest of product improvement POSEICO SpA reserves the right to change any data given in this data sheet at any time without previous notice.

If not stated otherwise the maximum value of ratings (symbols over shaded background) and characteristics is reported.

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